

Technical Specification BQ55090QZB84

35-55V
Continuous Input

9.6V Output 84A Current

2000V dc Isolation

Quarter-brick
DC-DC Converter

The BusQor BQ55090QZx84 bus converter is a next-generation, board-mountable, isolated, fixed switching frequency dc/dc converter that uses synchronous rectification to achieve extremely high conversion efficiency. The BusQor series provides an isolated step down voltage from 48V to 12 or 9.6V intermediate bus with no regulation in a standard "quarter-brick" module. BusQor converters are ideal for creating the mid-bus voltage required to drive point-of-load (non-isolated) converters in intermediate bus architectures.



BQ55090QZB84 Model

Protection Features

- Input under-voltage lockout and over-voltage shutdown protects against abnormal input voltages
- Output current limit and short circuit protection (auto recovery)
- Output over-voltage protection
- Thermal shutdown

Mechanical Features

- Industry standard quarter-brick pin-out configuration
- Size: 1.51" x 2.34" (38.4x59.4mm), height: 0.517" (13.13mm)
- Total baseplate weight: 2.89 oz (81.8 g)

Mechanical rediures

Control Features

- On/Off control referenced to input side (negative logic only)
- Inherent current share (by droop method) for high current and parallel applications.

Safety Features

- UL 60950-1:2007
- CAN/CSA-C22.2 No. 60950-1:2007
- EN60950-1:A12:2011
- IEC 61000-4-2

Operational Features

- High efficiency, 97% at full rated load current
- Delivers 84A full power with appropriate derating
- Operating input voltage range: 35-55V
- Fixed frequency switching provides predictable EMI
- No minimum load requirement

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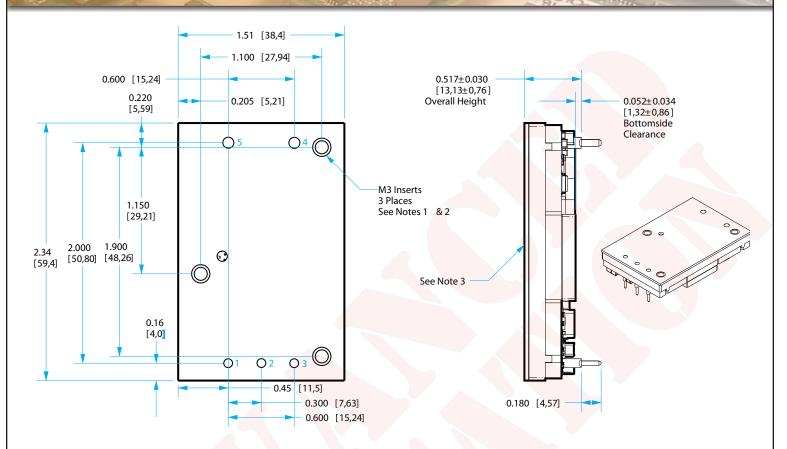
Product # BQ55090QZB84 Phone 1-888-567-9596 www.synqor.com Doc.# 005-0006255 Rev. 1



Baseplated Mechanical Diagram

Input: 35-55V Output: 9.6V Current: 84A

Package: Quarter-brick



NOTES

- 1) M3 screws used to bolt unit's baseplate to other surfaces such as heatsinks must not exceed 0.10" (2.54mm) depth below the surface of the baseplate.
- 2) Applied torque per screw should not exceed 6in-lb (0.7nm)
- 3) Baseplate flatness tolerance is 0.004" (.10mm) TIR for surface
- 4) Other pin extension lengths available
- 5) Pins 1-3 are 0.040" (1.02mm) dia. with 0.080" (2.03mm) dia. standoff shoulders 6) Pins 4 and 5 are 0.062" (1.57mm) dia. with 0.100" (2.54mm) dia.
- standoff shoulders
- 7) All pins: Material: Copper Alloy
 - Finish: Matte Tin over Nickel plate
- 8) Undimensioned components are shown for visual reference only
- 9) Weight: 2.7 oz (78 g) typical
- 10) All dimensions in inches(mm)

Tolerances: x.xxin +/-0.02 (x.xmm +/-0.5mm)x.xxxin +/-0.010 (x.xxmm +/-0.25mm)

PIN DESIGNATIONS

Pin	Name	Function
1	Vin(+)	Positive input voltage
2	ON/OFF	Logic control input to turn converter on/off.
3	Vin(-)	Negative input
4	Vout(-)	Negative output
5	Vout(+)	Positive output



Technical Specification

Input: 35-55V Output: 9.6V Current: 84A

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BQ55090QZB84 Electrical Characteristics

Ta = 25 °C, airflow rate = 300 LFM, Vin = 48V dc unless otherwise noted; full operating temperature range is -40 °C to +100 °C base plate temperature with appropriate power derating. Specifications subject to change without notice.

_				
		60		Continuous
35		55	V	Continuous
		2000	V	
-40		100	°C	
-55		125	°C	
-2		18	V	
35	48	55	V	
	33.4		V	
	31		V	
	2.4		V	
			V	
	56.9		V	
	59.2		V	
		24.5	Α	Vin = 35 V
		140	mA	
	3.5	5.5	mA	
	25	40	mA	RMS through 10µH inductor
	250		mA	RMS, full load
		30	A	Fast blow external fuse recommended
	47			Typical ESR 0.1-0.2 Ω
	0.22\30			Internal values; see Figure E
			part (par	Same Land Control of the Control of
	9.6		V	
	41.7\4.0		%\V	
6.300	=:= \===	11,000	,	Over sample, line, load, temperature & life
1.500				20 MHz bandwidth; see Note 2
	150	250	mV	Full load
				Full load
0		84		Subject to thermal derating
	92			Output Voltage 10% Low
				Negative current drawn from output
	10	5,000		9.6 Vout at 42 A Resistive Load
		3,000	μι	J.O VOGE GE 12 A RESISTIVE LOGG
	97 N		0/0	
			-	
	-55 -2	35 -40 -55 -2 35 48 33.4 31 2.4 56.9 59.2 3.5 25 250 47 0.22\30 9.6 41.7\4.0 6.25\600 2.1\200 6.300 150 50	35 2000 -40 100 -55 125 -2 18 35 48 55 33.4 31 2.4 56.9 59.2 24.5 140 3.5 5.5 25 40 250 30 47 0.22\30 30 47 0.22\30 6.25\600 2.1\200 6.300 11.000 150 250 50 50 6.5 10 5,000 5,000	35

Product # BQ55090QZB84



Technical Specification

Input: 35-55V Output: 9.6V Current: 84A

Package: Quarter-brick

BQ55090QZB84 Electrical Characteristics (continued)

Ta = 25 °C, airflow rate = 300 LFM, Vin = 48V dc unless otherwise noted; full operating temperature range is -40 °C to +100 °C base plate temperature with appropriate power derating. Specifications subject to change without notice.

DYNAMIC CHARACTERISTICS Output Voltage during Load Current Transient Step Change in Output Current (0.1 A/μs) Settling Time Turn-On Transient Turn-On Transient Turn-On Time (with 5mF output capacitance) Start-Up Inhibit Time Output Voltage Overshoot Stolation Voltage Overshoot Isolation Resistance Isolation Capacitance (input to output) Semiconductor Junction Temperature Base plate temperature Transformer Core Temperature Base plate temperature FEATURE CHARACTERISTICS Switching Frequency ON/OFF Control (Option N) On-State Voltage ON/OFF Control Pull-Up Voltage Over-Temperature Shutdown OTP Trip Point 140 DV Sow to 75% to 50% Iout max Sow 50% to 75% to 50% Iout max Sow to within 1% Vout nom To within 1% Vout nom ### Alf load, Vout=90% nom. ### Half load, Vout=90%	Notes & Conditions	nits	Max.	Тур.	Min.	Parameter
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Base plate temperature FEATURE CHARACTERISTICS Switching Frequency ON/OFF Control (Option N) On-State Voltage Off-State Voltage ON/OFF Controll Pull-Up Voltage Pull-Up Resistance Over-Temperature Shutdown OTP Trip Point 100 °C kHz 0.8 V 0.8 V Application notes Figures A & B V Application notes Figures A & B Cover-Temperature Shutdown OTP Trip Point 140 Cover-Temperature Shutdown OTP Trip Point	UL rated max operating temp 130 °C	°C	125			Board Temperature
FEATURE CHARACTERISTICS Switching Frequency 120 140 160 kHz ON/OFF Control (Option N) 0.8 V On-State Voltage -1 0.8 V Off-State Voltage 2.4 18 V ON/OFF Controll Application notes Figures A & B Pull-Up Voltage 3.3 V Pull-Up Resistance 100 kΩ Over-Temperature Shutdown OTP Trip Point 140 150 °C Average PCB Temperature		°C	130			Transformer Core Temperature
Switching Frequency 120 140 160 kHz ON/OFF Control (Option N) 0.8 V On-State Voltage -1 0.8 V OFF-State Voltage 2.4 18 V ON/OFF Controll Application notes Figures A & B Pull-Up Voltage 3.3 V Pull-Up Resistance 100 kΩ Over-Temperature Shutdown OTP Trip Point 140 150 °C Average PCB Temperature		°C	100			Base plate temperature
ON/OFF Control (Option N) 0.8 V On-State Voltage -1 0.8 V Off-State Voltage 2.4 18 V ON/OFF Controll Application notes Figures A & B Pull-Up Voltage 3.3 V Pull-Up Resistance 100 kΩ Over-Temperature Shutdown OTP Trip Point 140 150 °C Average PCB Temperature						FEATURE CHARACTERISTICS
On-State Voltage Off-State Voltage ON/OFF Controll Pull-Up Voltage Pull-Up Resistance Over-Temperature Shutdown OTP Trip Point On-State Voltage 2.4 18 V Application notes Figures A & B V Application notes Figu		Hz	160	140	120	Switching Frequency
Off-State Voltage ON/OFF Controll Pull-Up Voltage Pull-Up Resistance Over-Temperature Shutdown OTP Trip Point 2.4 18 V Application notes Figures A & B V Application notes Fig						ON/OFF Control (Option N)
ON/OFF Controll Pull-Up Voltage Pull-Up Resistance Over-Temperature Shutdown OTP Trip Point Application notes Figures A & B V Location Notes Figures A & B V Application notes Figures A & B V Application notes Figures A & B V Application notes Figures A & B V Average PCB Temperature		٧	0.8		-1	On-State Voltage
Pull-Up Voltage 3.3 V Pull-Up Resistance 100 kΩ Over-Temperature Shutdown OTP Trip Point 140 150 °C Average PCB Temperature		٧	18		2.4	Off-State Voltage
Pull-Up Resistance 100 kΩ Over-Temperature Shutdown OTP Trip Point 140 150 °C Average PCB Temperature	Application notes Figures A & B					ON/OFF Controll
Over-Temperature Shutdown OTP Trip Point 140 150 °C Average PCB Temperature		٧		3.3		Pull-Up Voltage
		kΩ		100		Pull-Up Resistance
Over-Temperature Shutdown Restart Hysteresis 10 °C	Average PCB Temperature	°C	150		140	Over-Temperature Shutdown OTP Trip Point
		°C		10		Over-Temperature Shutdown Restart Hysteresis
RELIABILITY CHARACTERISTICS						RELIABILITY CHARACTERISTICS
Calculated MTBF (Telcordia) TR-NWT-000332 TBD 106 Hrs. 80% load, 200LFM, 40 °C Ta	 80% load, 200LFM, 40 °C Ta	Hrs.		TBD		Calculated MTBF (Telcordia) TR-NWT-000332
Calculated MTBF (MIL-217) MIL-HDBK-217F TBD 106 Hrs. 80% load, 200LFM, 40 °C Ta	80% load, 200LFM, 40 °C Ta	Hrs.		TBD		Calculated MTBF (MIL-217) MIL-HDBK-217F
Field Demonstrated MTBF 106 Hrs. See our website for details	See our website for details	Hrs.				Field Demonstrated MTBF

Note 1: UL's product certification tests were carried out using 30A fast blow fuse. Fuse interruption characteristics have to be taken into account while designing input traces. User should ensure that Input trace is capable of withstanding fault currents

Note 2: For applications requiring reduced output voltage ripple and noise, consult SynQor applications support (e-mail: support@synqor.com)

Note 3: Isolation capacitance can be added external to the module.

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Package: Quarter-brick

Standards Compliance & Qualification Testing

 Parameter
 Notes & Conditions

 STANDARDS COMPLIANCE
 UL 60950-1:2007

 UL 60950-1:2007
 Basic insulation

 CAN/CSA-C22.2 No. 60950-1:2007
 EN60950-1:A12:2011

 IEC 61000-4-2
 ESD test, 8 kV - NP, 15 kV air - NP (Normal Performance)

Note: An external input fuse must always be used to meet these safety requirements. Contact SynQor for official safety certificates on new releases or download from the SynQor website.

Parameter	# Units	Test Conditions
QUALIFICATION TESTING		
Life Test	32	95% rated Vin and load, units at derating point, 1000 hours
Vibration	5	10-55 Hz sweep, 0.060" total excursion, 1 min./sweep, 120 sweeps for 3 axis
Mechanical Shock	5	100g minimum, 2 drops in x, y and z axis
Temperature Cycling	10	-40 °C to 100 °C, unit temp. ramp 15 °C/min., 500 cycles
Power/Thermal Cycling	5	Toperating = min to max, Vin = min to max, full load, 100 cycles
Design Marginality	5	Tmin-10 °C to Tmax+10 °C, 5 °C steps, Vin = min to max, 0-105% load
Humidity	5	85 °C, 85% RH, 1000 hours, continuous Vin applied except 5 min/day
Solderability	15 pins	MIL-STD-883, method 2003

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Input: 35-55V Output: 9.6V Current: 84A Package: Quarter-brick

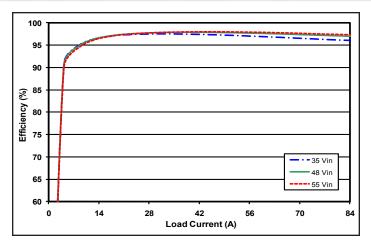


Figure 1: Efficiency at nominal output voltage vs. load current for minimum, nominal, and maximum input voltage at 25°C.

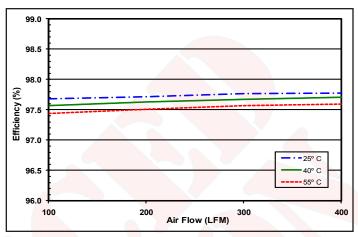


Figure 2: Efficiency at nominal output voltage and 60% rated power vs. airflow rate for ambient air temperatures of 25°C, 40°C, and 55°C (nominal input voltage).

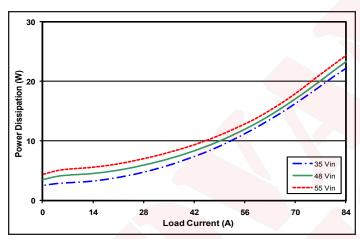


Figure 3: Power dissipation at nominal output voltage vs. load current for minimum, nominal, and maximum input voltage at 25°C.

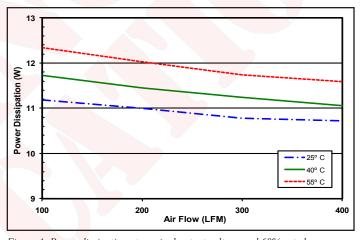


Figure 4: Power dissipation at nominal output voltage and 60% rated power vs. airflow rate for ambient air temperatures of 25°C, 40°C, and 55°C (nominal input voltage).

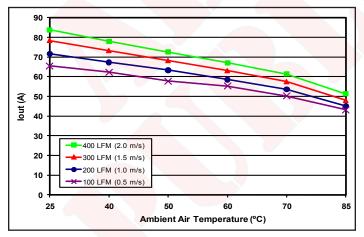


Figure 5: Maximum output current derating curve vs. ambient air temperature (with baseplate only) at different airflow rates with air flowing from output to input (nominal input voltage).

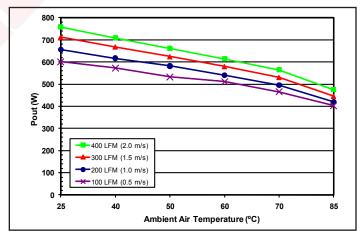


Figure 6: Maximum output power derating curve vs. ambient air temperature (with baseplate only) at different airflow rates with air flowing from output to input (nominal input voltage).

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Package: Quarter-brick

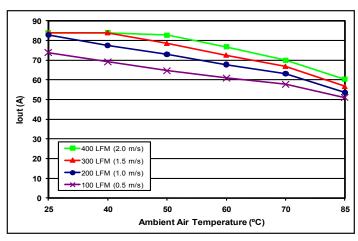


Figure 7: Maximum output current derating curve vs. ambient air temperature (with both baseplate and ¼" heat sink) at different airflow rates with air flowing from output to input (nominal input voltage).

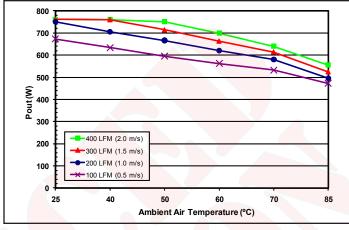


Figure 8: Maximum output power derating curve vs. ambient air temperature (with both baseplate and ¼" heat sink) at different airflow rates with air flowing from output to input (nominal input voltage).

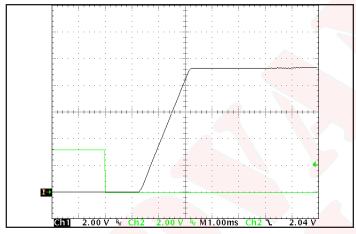


Figure 9: Turn-on transient at half load (resistive load) (1 ms/div). Load cap: 15µF tantalum capacitor and 5mF ceramic capacitor bank. Input voltage preapplied. Ch 1: Vout (2V/div). Ch 2: ON/OFF input (2 V/div).

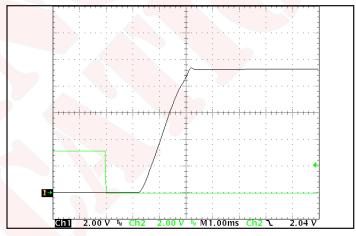


Figure 10: Turn-on transient at zero load (1 ms/div). Load cap: $15\mu F$ tantalum capacitor and 5mF ceramic capacitor bank. Ch 1: Vout (2V/div), Ch 2: ON/OFF input (2V/div).

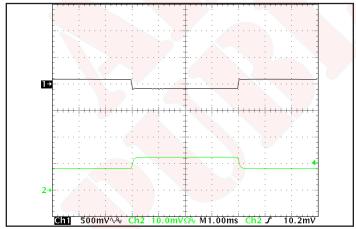


Figure 11: Output voltage response to step-change in load current (50%-75%-50% of lout(max); $dI/dt = 0.1A/\mu s$). Load cap: $15\mu F$ tantalum cap and $1\mu F$ ceramic cap. Ch 1: Vout (500mV/div), Ch 2: lout (50A/div).

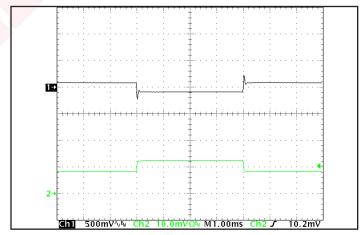


Figure 12: Output voltage response to step-change in load current (50%-75%-50% of lout(max): $dI/dt = 1A/\mu s$). Load cap: $15\mu F$, 30 m Ω ESR tantalum cap and $1\mu F$ ceramic cap. Ch 1: Vout (500mV/div), Ch 2: lout (50A/div).



Current: 84A
Package: Quarter-brick

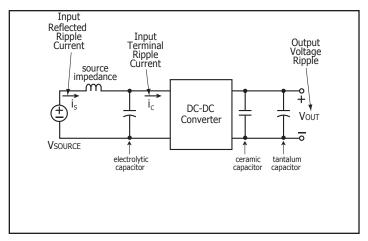


Figure 13: Test set-up diagram showing measurement points for Input Terminal Ripple Current (Figure 14), Input Reflected Ripple Current (Figure 15) and Output Voltage Ripple (Figure 16).

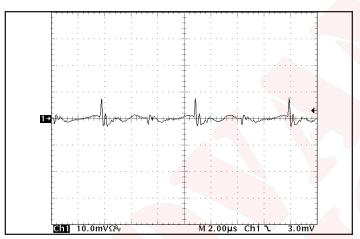


Figure 15: Input reflected ripple current, is, through a $10\mu H$ source inductor, using a $47\mu F$ electrolytic input capacitor (100mA/div). See Figure 13.

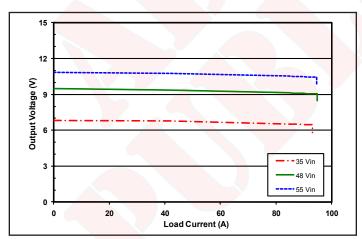


Figure 17: Output voltage vs. load current for different input voltages showing typical current limit curves.

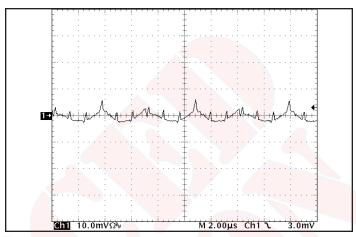


Figure 14: Input Terminal Ripple Current, ic, at full rated output current and nominal input voltage with $10\mu H$ source impedance and $47\mu F$ electrolytic capacitor (1 A/div). See Figure 13.

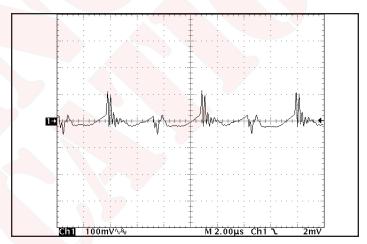


Figure 16: Output voltage ripple at nominal input voltage and rated load current (100mV/div). Load capacitance: 1μF ceramic capacitor and 15μF tantalum capacitor. Bandwidth: 20MHz. See Figure 13.

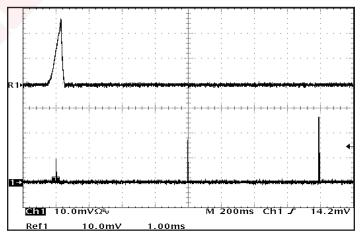


Figure 18: Load current (50A/div) as a function of time when the converter attempts to turn on into a $Im\Omega$ short circuit. Top trace (Ims/div) is an expansion of the on-time portion of the bottom trace.



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BASIC OPERATION AND FEATURES

With voltages dropping and currents rising, the economics of an Intermediate Bus Architecture (IBA) are becoming more attractive, especially in systems requiring multiple low voltages. IBA systems separate the role of isolation and voltage scaling from regulation and sensing. The BusQor series bus converter provides isolation and an unregulated voltage step down in one compact module, leaving regulation to simpler, less expensive non-isolated converters.

In Figure A below, the BusQor module provides the isolation stage of the IBA system. The isolated bus then distributes power to the non-isolated buck regulators to generate the required voltage levels at the points of load. In this case, the bucks are represented with SynQor's NiQor series of nonisolated DC/DC converters. In many applications requiring multiple low voltage outputs, significant savings can be achieved in board space and overall system costs

When designing an IBA system with bus converters, the designer can select from a variety of bus voltages. While there is no universally ideal bus voltage, most designs employ one of the following: 12V, 9.6V, 7.5V, 5V, or 3.3V. Higher bus voltages can lead to lower efficiency for the buck regulators but are more efficient for the bus converter and provide lower board level distribution current. Lower bus voltages offer the opposite trade offs.

SynQor's BusQor modules act as a true dc transformer. The output voltage is proportional to the input voltage, with a specified "turns ratio" or voltage ratio, plus minor drop from the internal resistive losses in the module. When used in IBA systems, the output variation of the BusQor must be in accordance with the input voltage range of the non-isolated converters being employed.

The BusQor architecture is very scalable, meaning multiple bus converters can be connected directly in parallel to allow current sharing for higher power applications.

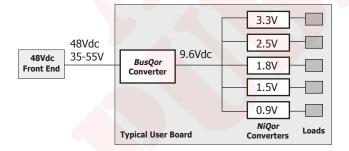


Figure A: Example of Intermediate Bus Architecture using BusQor bus converter and NiOor non-isolated converters

CONTROL FEATURES

REMOTE ON/OFF (Pin 2): The ON/OFF input, Pin 2, permits the user to control when the converter is on or off. This input is referenced to the return terminal of the input bus, Vin(-).

In the negative logic version, the ON/OFF signal is active low (meaning that a low turns the converter on). Figure B is a detailed look of the internal ON/OFF circuitry.

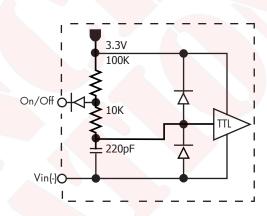


Figure B: Internal ON/OFF pin circuitry



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PROTECTION FEATURES

Input Under-Voltage Lockout: The converter is designed to turn off when the input voltage is too low, helping avoid an input system instability problem, described in more detail in the application note titled "Input System Instability". The lockout circuitry is a comparator with DC hysteresis. When the input voltage is rising, it must exceed the typical Turn-On Voltage Threshold value (listed on the specification page) before the converter will turn on. Once the converter is on, the input voltage must fall below the typical Turn-Off Voltage Threshold value before the converter will turn off. Also see Figure E.

Output Current Limit: The output of the BusQor module is electronically protected against output overloads. When an overload current greater than the "DC Current-Limit Inception" specification is drawn from the output, the output shuts down to zero volt in a period of 10ms typical (see Figure D). The shutdown period lasts for a typical period of 800ms (Figure D) after which the BusQor tries to power up again. If the overload persists, the output voltage will go through repeated cycles of shutdown and restart with a duty cycle of 1.25% (On) and 98.75% (Off) respectively. The BusQor module returns (auto resetting) to normal operation once the overload is removed. The BusQor is designed to survive in this mode indefinitely without damage and without human intervention.

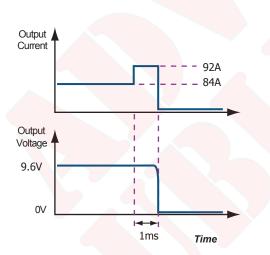


Figure C: Output Overload protection diagram (not to scale)

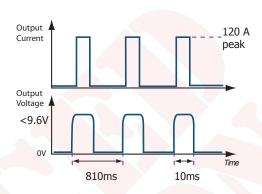


Figure D: Output Short Circuit and Auto-Resetting protection diagram (not to scale)

Output Short Circuit Protection: When the output of the BusQor module is shorted, a peak current of typically 120 A will flow into the short circuit for a period of about 1ms. The output of the BusQor will shutdown to zero for ~ 800mS (Figure D). At the end of the shutdown period the BusQor module tries to power up again. If the short circuit persists, the output voltage will go through repeated cycles of shutdown and restart with a duty cycle of 1.25% (On) and 98.75% (Off) respectively. The BusQor module returns (auto resetting) to normal operation once the short circuit is removed. The BusQor is designed to survive in this mode indefinitely without damage and without human intervention.

In the Auto resetting mode, also referred to as "Hiccup" mode, the power drawn from the 48V input is about 3 Watts, most of which is dissipated into the external fault. It is important that copper traces and pads from the output circuit be designed to withstand the short term peaks, although the average current into the fault may be as low as 0.1A typical. See Figure 18 for appropriate waveform.

Over-Temperature Shutdown: A temperature sensor on the converter senses the average temperature of the module. The thermal shutdown circuit is designed to turn the converter off when the temperature at the sensed location reaches the Over-Temperature Shutdown value. It will allow the converter to turn on again when the temperature of the sensed location falls by the amount of the Over-Temperature Shutdown Restart Hysteresis value.



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APPLICATION CONSIDERATIONS

Start-Up Inhibit Period: Figure E details the Start-Up Inhibit Period for the BusQor module. At time t0, when Vin is applied with On/Off pin asserted (enabled), the BusQor output begins to build up. Before time t1, when the input voltage is below the UVL threshold, the unit is disabled by the Input Under-Voltage Lockout feature. When the input voltage rises above the UVL threshold, the Input Under-Voltage Lockout is released, and a typical Startup Inhibit Period of 12ms is initiated. The output builds up to 90% of the nominal value of 9.6V in a period of 5ms typical (50 % load).

At time t2, when the On/Off pin is de-asserted (disabled), the BusQor output instantly drops to 0V. Fall time from 9.6V to 0V is dependent on output capacitance and any parasitic trace inductance in the output load circuit.

At time t3, when the On/Off pin is re-asserted (enabled), the BusQor module output begins to build up after the inhibit period of 800 ms typical has elapsed.

Refer to the Control Features section of the data sheet for details on enabling and disabling methods for Bus Qor modules.

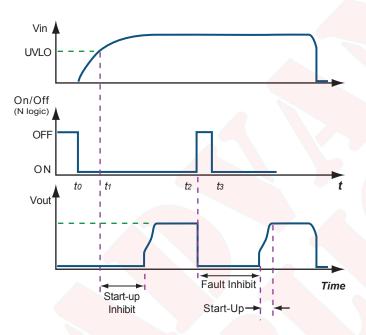


Figure E: Power Up/Down Diagram (not to scale) showing Start-Up Inhibit Period

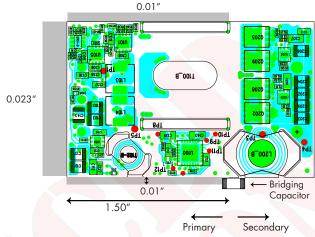


Figure F: Keep Out Areas for BusQor module (view from bottom)

Component Keep Out Area: Keep out areas for components not referenced to the Primary circuit are shown in shaded areas in Figure F. The keep out areas shown are consistent with UL's requirements for Basic Insulation of 0.04" (40 mils) for Pollution degree 2. User should consult UL standards for other insulation classes and operating environments.

For applications that require mounting parts BELOW the BusQor module, one should be aware of potential high levels of electromagnetic interference, in addition to safety keep out. Users are advised to consult SynQor Applications engineering in such applications.

Copper Keep Out Area: Keep out areas shown in Figure F are to be observed for Top layer copper traces and vias. Internal layers buried one or more layers may be exempt, depending on the PCB material grade and thickness. Users are advised to consult UL standards for details.

All layers including top and bottom, are subject to the keep out areas shown around Primary pins of BusQor module. Actual keep outs along the surface (Creepage) may vary depending on the PCB material CTI. Users are advised to consult UL standards for details.

Bridging Components: Bridging components like EMI filter capacitors required to be placed as close as possible to the BusQor module for optimum performance must observe the clearance/creepage requirements of 0.04''(40 mils) between pads to maintain compliance to UL standards for the overall power system.

Note: Referenced keep out widths are adequate to withstand UL's Basic Insulation Dielectric strength tests for approved PCB materials. Applications requiring Double or Reinforced insulation must double the keep out widths shown in Figure F. Keep out areas shown have standard margins above UL's minimum requirements.



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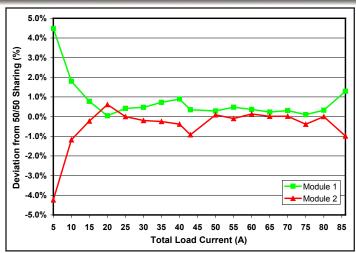


Figure G: Current share performance of 2 paralleled modules

Current Sharing: BusQor modules are designed to operate in parallel without the use of any external current share circuitry. A typical circuit for paralleling two BusQor modules is shown in Figure G. An output capacitor is recommended across each module and located close to the converter for optimum filtering and noise control performance. Dedicated input inductors are recommended but are considered optional. Input capacitors must be located close to the converter module. PCB layout in the input circuit should be such that high frequency ripple currents of each module is restricted to a loop formed by the input capacitors and the input terminals of the BusQor module. See Figure H for details on PCB layout. Contact SynQor application engineering for further assistance on PCB trace design.

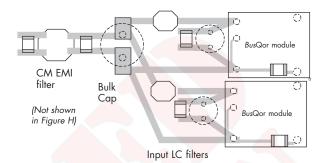


Figure H: Recommended PCB layout for input circuit 48Vin

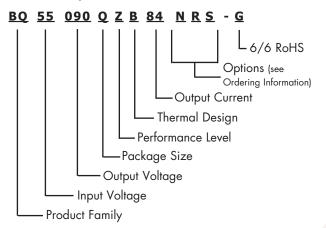
The current share performance of two paralleled modules is illustrated in the graph in Figure H. In this graph the percent deviation from ideal sharing (50%) is plotted for each module versus the total output load current at 48Vin.



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Part Numbering System

The part numbering system for SynQor's dc-dc converters follows the format shown in the example below.



The first 12 characters comprise the base part number and the last 3 characters indicate available options. The "-G" suffix indicates 6/6 RoHS compliance.

Application Notes

A variety of application notes and technical white papers can be downloaded in pdf format from our website.

RoHS Compliance: The EU led RoHS (Restriction of Hazardous Substances) Directive bans the use of Lead, Cadmium, Hexavalent Chromium, Mercury, Polybrominated Biphenyls (PBB), and Polybrominated Diphenyl Ether (PBDE) in Electrical and Electronic Equipment. This SynQor product is 6/6 RoHS compliant. For more information please refer to SynQor's RoHS addendum available at our RoHS Compliance / Lead Free Initiative web page or e-mail us at rohs@synqor.com.

Ordering Information

The tables below show the valid model numbers and ordering options for converters in this product family. When ordering SynQor converters, please ensure that you use the complete 15 character part number consisting of the 12 character base part number and the additional characters for options. Add "-G" to the model number for 6/6 RoHS compliance.

Model Number	Input Voltage	Output Voltage	Max Output Current
BQ55090QZB84xyz-G	35-55V	9.6V	84A

The following options must be included in place of the $w \times y \times z$ spaces in the model numbers listed above.

Options Description: w x y z							
Thermal Design		Enable Logic	Pin Style	Feature Set			
B - B	aseplated	N - Negative	K - 0.110" N - 0.145" R - 0.180" Y - 0.250"	S - Standard			

Not all combinations make valid part numbers, please contact SynQor for availability. See the Product Summary web page for more options.

PATENTS

SynQor holds the following U.S. patents, one or more of which apply to each product listed in this document. Additional patent applications may be pending or filed in the future.

5,999,417	6,222,742	6,545,890	6,577,109	6,594,159	6,731,520
6,894,468	6,896,526	6,927,987	7,050,309	7,072,190	7,085,146
7,119,524	7,269,034	7,272,021	7,272,023	7,558,083	7,564,702
7,765,687	7,787,261	8,023,290	8,149,597		

Warranty

SynQor offers a three (3) year limited warranty. Complete warranty information is listed on our website or is available upon request from SynQor.

Information furnished by SynQor is believed to be accurate and reliable. However, no responsibility is assumed by SynQor for its use, nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of SynQor.

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